



General Description

The SJJ60N043 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 10V. This device is suitable for use as a wide variety of applications.

Features

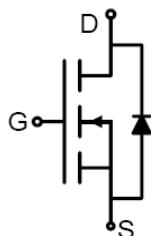
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handing capability
- Lead free product is acquired

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

Key Performance Parametes

| Parameter | Value | Unit |
|--------------------|-------|------|
| V_{DS} | 60 | V |
| $R_{DS(ON)}_{TYP}$ | 4.5 | mΩ |
| I_D | 100 | A |
| Q_G | 76 | nC |



Schematic Diagram



TO-263 top view

Package Marking and Ordering Information

| Device/Ordering Code | Marking | Package | Packing | Reel Size | Tape width | Quantity |
|----------------------|-----------|---------|---------|-----------|------------|----------|
| SJJ60N043 | SJJ60N043 | TO-263 | Tape | \ | \ | 1000 Pcs |

Table 1. Absolute Maximum Ratings ($T_c=25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter | Limit | Unit |
|-------------------|--|------------|------|
| V_{DS} | Drain-Source Voltage ($V_{GS}=0\text{V}$) | 60 | V |
| V_{GS} | Gate-Source Voltage ($V_{DS}=0\text{V}$) | ± 20 | V |
| I_D | Drain Current-Continuous($T_c=25^\circ\text{C}$) | 100 | A |
| | Drain Current-Continuous($T_c=100^\circ\text{C}$) | 64 | A |
| I_{DM} (pulse) | Drain Current-Continuous@ Current-Pulsed (Note 1) | 400 | A |
| P_D | Maximum Power Dissipation($T_c=25^\circ\text{C}$) | 121 | W |
| | Maximum Power Dissipation($T_c=100^\circ\text{C}$) | 49 | W |
| E_{AS} | Avalanche energy (Note 2) | 400 | mJ |
| T_J , T_{STG} | Operating Junction and Storage Temperature Range | -55 To 150 | °C |

Table 2. Thermal Characteristic

| Symbol | Parameter | Typ | Max | Unit |
|-----------|--------------------------------------|-----|------|------|
| R_{eJC} | Thermal Resistance, Junction-to-Case | | 1.03 | °C/W |



60V N-Channel Trench Power MOSFET

Table 3. Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---|-----------------------------------|---|-----|------|-----------|------------------|
| On/Off States | | | | | | |
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{\text{GS}}=0\text{V}$ $I_{\text{D}}=250\mu\text{A}$ | 60 | | | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{\text{DS}}=60\text{V}$, $V_{\text{GS}}=0\text{V}$ $T_J=25^\circ\text{C}$ | | | 1 | μA |
| | | $V_{\text{DS}}=60\text{V}$, $V_{\text{GS}}=0\text{V}$ $T_J=125^\circ\text{C}$ | | | 100 | μA |
| I_{GSS} | Gate-Body Leakage Current | $V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$ | | | ± 100 | nA |
| $V_{\text{GS(th)}}$ | Gate Threshold Voltage | $V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{D}}=250\mu\text{A}$ | 2 | | 4 | V |
| g_{FS} | Forward Transconductance | $V_{\text{DS}}=10\text{V}$, $I_{\text{D}}=20\text{A}$ | | 36.5 | | S |
| $R_{\text{DS(ON)}}$ | Drain-Source On-State Resistance | $V_{\text{GS}}=10\text{V}$, $I_{\text{D}}=20\text{A}$ $T_J=25^\circ\text{C}$ | | 4.5 | 5.6 | $\text{m}\Omega$ |
| Dynamic Characteristics | | | | | | |
| C_{iss} | Input Capacitance | $V_{\text{DS}}=30\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1.0\text{MHz}$ | | 4762 | | pF |
| C_{oss} | Output Capacitance | | | 265 | | pF |
| C_{rss} | Reverse Transfer Capacitance | | | 230 | | pF |
| R_g | Gate resistance | $V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=0\text{V}$, $f=1.0\text{MHz}$ | | 0.86 | | Ω |
| Switching Parameters | | | | | | |
| $t_{\text{d(on)}}$ | Turn-on Delay Time | $V_{\text{GS}}=10\text{V}$, $V_{\text{DS}}=30\text{V}$, $R_L=1.5\Omega$, $R_{\text{GEN}}=3\Omega$ | | 20 | | nS |
| t_r | Turn-on Rise Time | | | 90 | | nS |
| $t_{\text{d(off)}}$ | Turn-Off Delay Time | | | 37 | | nS |
| t_f | Turn-Off Fall Time | | | 85 | | nS |
| Q_g | Total Gate Charge | $V_{\text{GS}}=10\text{V}$, $V_{\text{DS}}=30\text{V}$, $I_{\text{D}}=20\text{A}$ | | 76 | | nC |
| Q_{gs} | Gate-Source Charge | | | 21 | | nC |
| Q_{gd} | Gate-Drain Charge | | | 24 | | nC |
| Source-Drain Diode Characteristics | | | | | | |
| I_{SD} | Source-Drain Current (Body Diode) | | | | 100 | A |
| V_{SD} | Forward on Voltage (Note 3) | $V_{\text{GS}}=0\text{V}$, $I_{\text{S}}=20\text{A}$ | | | 1.2 | V |
| t_{rr} | Reverse Recovery Time | $I_F=20\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$ | | 25 | | ns |
| Q_{rr} | Reverse Recovery Charge | $I_F=20\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$ | | 30 | | nC |

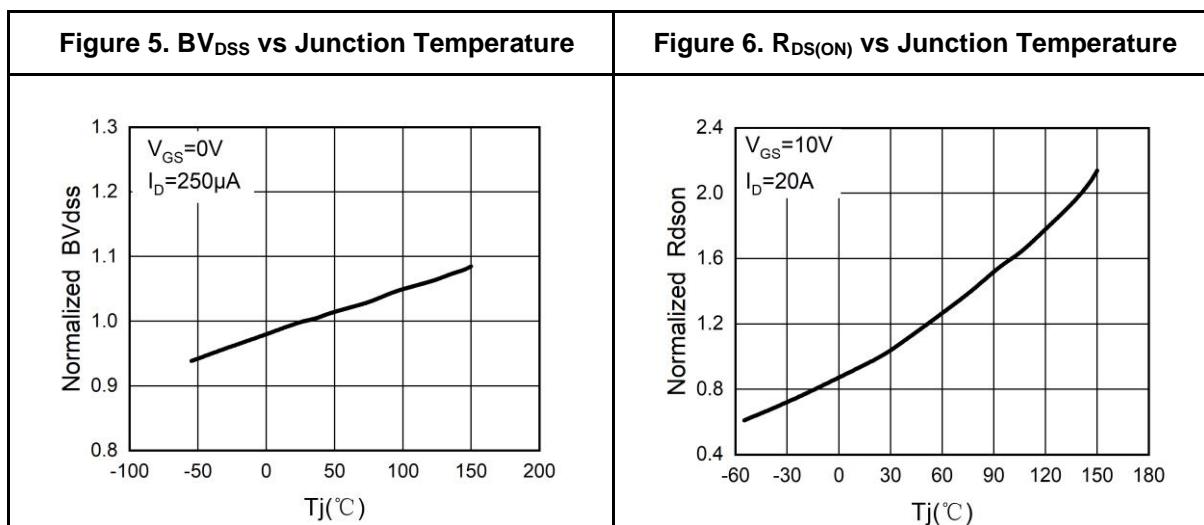
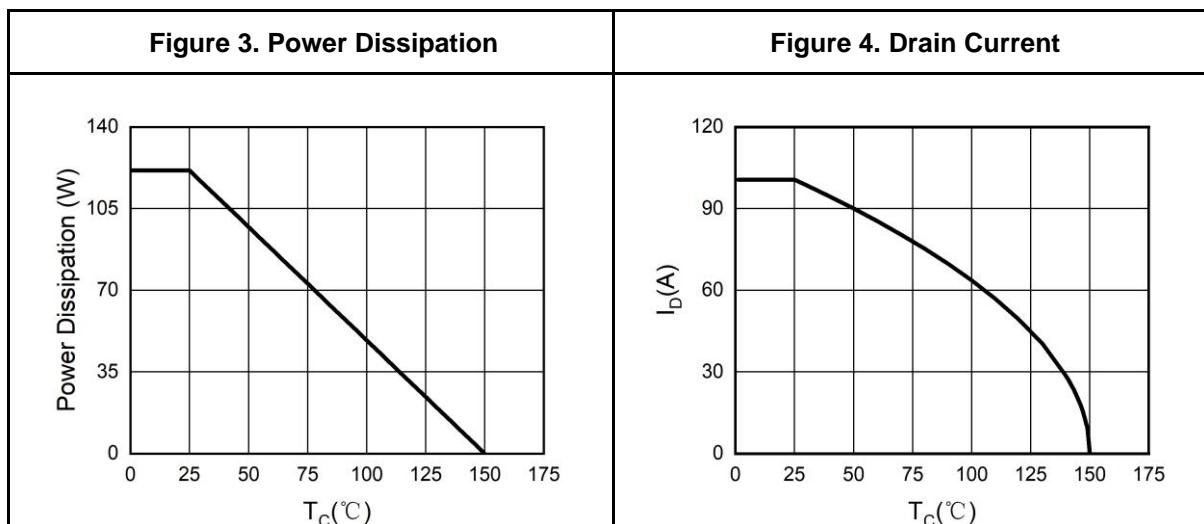
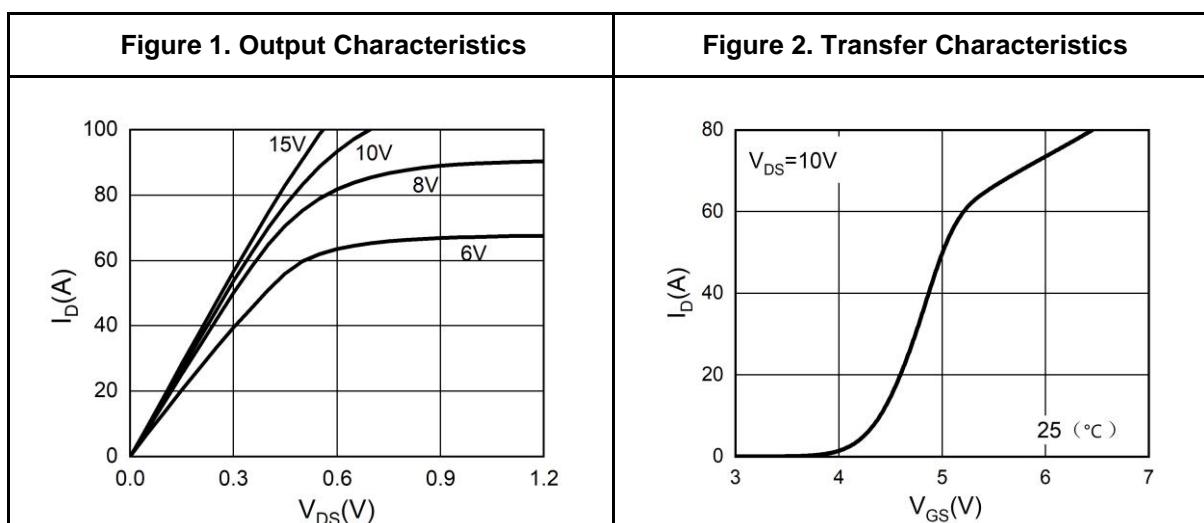
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

Notes 2.E_{AS} condition: $T_J=25^\circ\text{C}$, $V_{\text{DD}}=40\text{V}$, $V_{\text{G}}=10\text{V}$, $R_g=25\Omega$, $L=0.5\text{mH}$.

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.



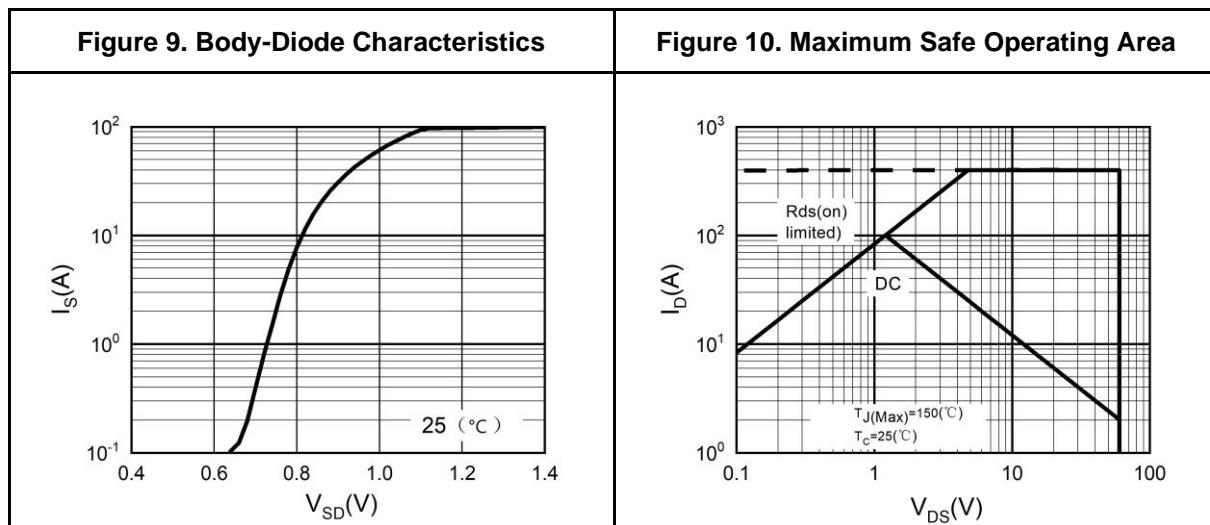
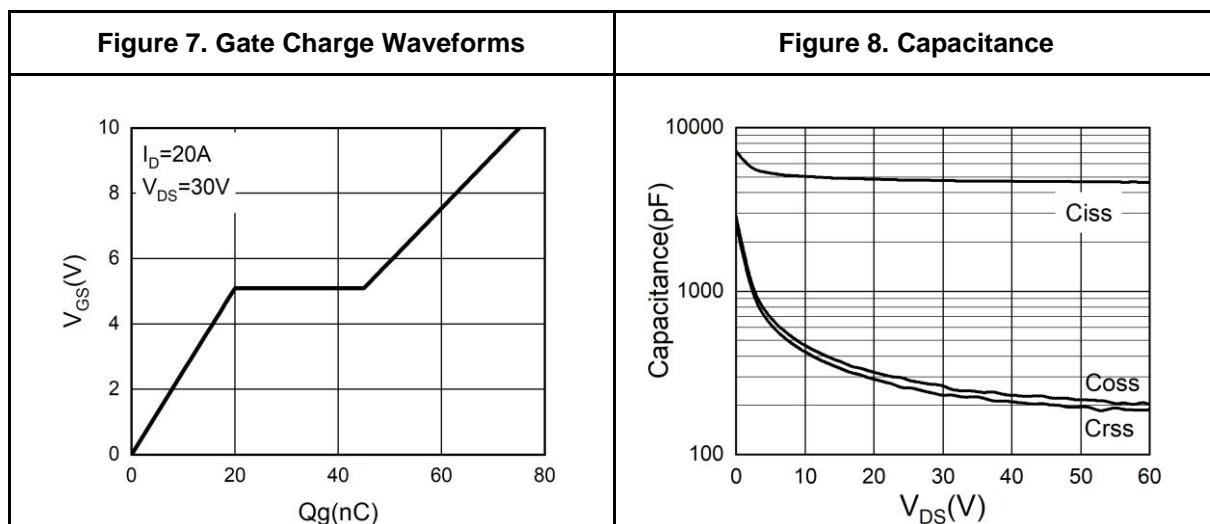
Typical Electrical And Thermal Characteristics (Curves)





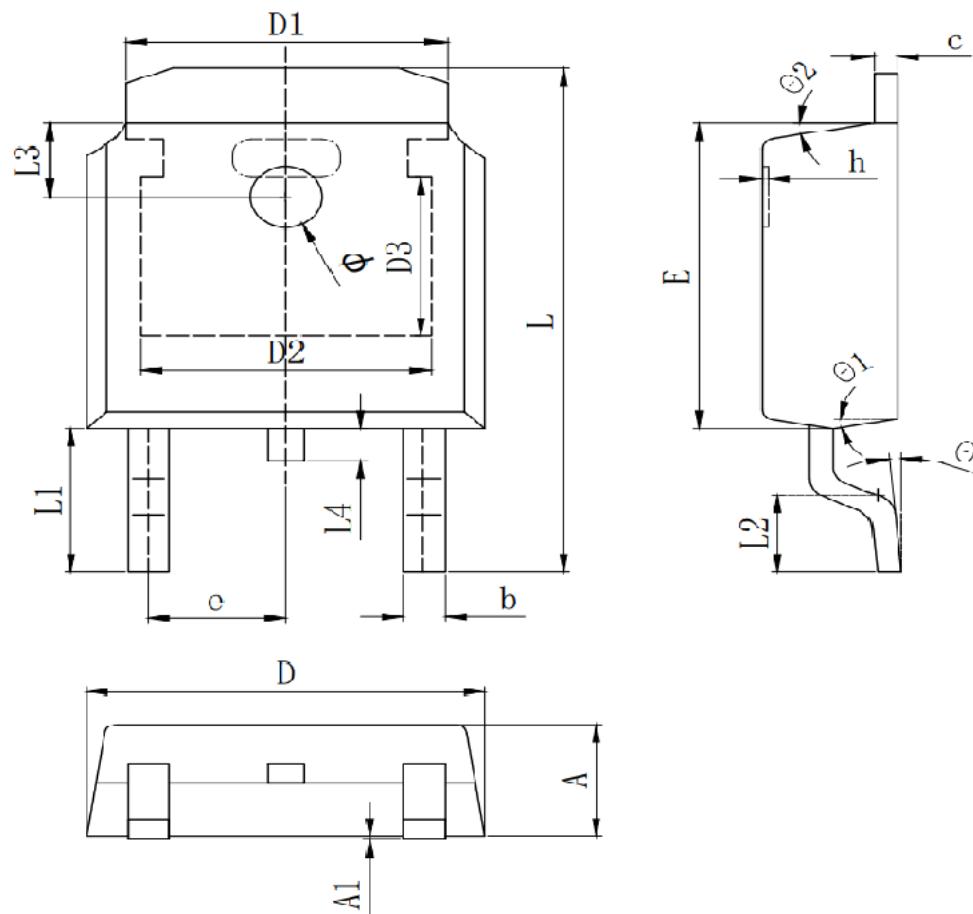
60V N-Channel Trench Power MOSFET

Typical Electrical And Thermal Characteristics (Curves)





TO-263 Package Information



| Symbol | Dimensions In Millimeters | | |
|--------|---------------------------|-----------|--------|
| | Min. | Typ. | Max. |
| A | 2.200 | 2.300 | 2.400 |
| A1 | 0.000 | | 0.127 |
| b | 0.640 | 0.690 | 0.740 |
| c(电镀后) | 0.460 | 0.520 | 0.580 |
| D | 6.500 | 6.600 | 6.700 |
| D1 | | 5.334 REF | |
| D2 | | 4.826 REF | |
| D3 | | 3.166 REF | |
| E | 6.000 | 6.100 | 6.200 |
| e | | 2.286 TYP | |
| h | 0.000 | 0.100 | 0.200 |
| L | 9.900 | 10.100 | 10.300 |
| L1 | | 2.888 REF | |
| L2 | 1.400 | 1.550 | 1.700 |
| L3 | | 1.600 REF | |
| L4 | 0.600 | 0.800 | 1.000 |
| Φ | 1.100 | 1.200 | 1.300 |
| θ | 0° | | 8° |
| θ1 | | 9° TYP | |
| θ2 | | 9° TYP | |



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